# **Sensors, Signals and Noise**

# COURSE OUTLINE

- Introduction
- Signals and Noise
- Filtering
- Sensors: PD3 Semiconductor PhotoDiodes

- Semiconductor PhotoDiode (PD) devices and carrier motion
- I-V characteristics and stationary equivalent circuit of PDs
- Dark-Current, sensitive area, and photon detection efficiency
- Current signal in PDs and dynamic response

# PhotoDiode (PD) devices and carrier motion

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# **Basic Device Structure of Photodiodes**

**Reverse biased** p-n junction:  $V_A > 0$ 



on-chip optical connections

can be designed with flexibility and can attain wide size

## **Carrier motion in PD**



# **Carrier motion and Current in PD**

#### Carriers generated in the depleted layer:

- A carrier in the depleted layer induces opposite charges in the conductive electrodes (neutral semiconductor layer and metal contact to the external circuit)
- The value of the induced charge on a given electrode depends on the carrier distance from the electrode
- If the carrier moves the **charge induced on the electrode varies**, hence current flows through the contact

**Conclusion:** a carrier drifting in the depleted layer **causes current to flow** through the metal contact to the external circuit

#### **Carriers generated in neutral regions:**

- A carrier in a neutral region is surrounded by a huge population of other free carriers
- When the carrier moves the distribution of free carriers swiftly rearranges itself to electrically screen any effect of the carrier motion on the external circuit

**Conclusion**: **as long as it diffuses** in a neutral region, a carrier **does NOT cause current** to flow through the metal contact to the external circuit. However, **if** by diffusion it reaches the edge of depletion layer before recombining, **then** it drifts in the electric field and causes current to flow.

# **I-V characteristics of PhotoDiodes**

# **I-V** characteristics of PD



# **Stationary operation of PD**

**LINEAR PHOTOCURRENT MODE:** PD with high reverse bias  $V_A \gg kT/q$ 

![](_page_8_Figure_2.jpeg)

# Dark-Current, sensitive area and photon detection efficiency

# Photon Detection Efficiency $\eta_D$

 $P_d$  = probability of a photon to generate a free electron-hole pair **in the depletion layer** = product of probabilities of

- 1. NOT being reflected at the surface
- 2. NOT being absorbed in the top neutral layer  $w_n$
- 3. BEING absorbed in the depletion layer  $w_d$

Denoting by R the reflectivity (probability of reflection) and  $L_a=1/\alpha$  optical absorption depth:

$$P_d = (1 - R) \cdot e^{-\alpha w_n} \cdot (1 - e^{-\alpha w_d})$$

![](_page_10_Figure_7.jpeg)

In most PD structures the probability that carriers photogenerated in neutral regions reach by diffusion the depletion layer is negligible, hence the photon detection efficiency or quantum detection efficiency  $\eta_D$  is simply

$$\eta_D = P_d = (1-R) \cdot e^{-\frac{W_n}{L_a}} \cdot \left(1 - e^{-\frac{W_d}{L_a}}\right)$$

![](_page_10_Picture_10.jpeg)

In PD structures where carriers diffusing in neutral regions have significant probability of reaching the depletion region, additional contributions to  $\eta_D$  must be taken into account

# **Photon Detection Efficiency ηD**

$$\eta_D = P_d = (1-R) \cdot e^{-\frac{W_n}{L_a}} \cdot (1-e^{-\frac{W_d}{L_a}})$$

Basic sources of  $\eta_D$  losses are 1) surface reflection, 2) absorption in the neutral input layer and 3) incomplete absorption in the depletion layer (active volume). The  $\eta_D$  value attained depends on the actual material properties and PD structure and on the light wavelength  $\lambda$ .

#### $\eta_D$ loss by Reflection

- The reflection at vacuum-semiconductor surface is strong because of the high step discontinuity in refractive index n, since n is high in semiconductors. In Silicon n>3,5 over all the visible range and further rises at short λ; the reflectivity is accordingly high R>30% and further rises at short λ.
- Losses can be reduced by **tapering the n-transition** with deposition of a multi-layer anti-reflection (AR) coating of materials with n values suitably scaled down from semiconductor to vacuum. Strong reduction can be obtained, down to R<<10%.

# **Photon Detection Efficiency ηD**

$$\eta_D = P_d = (1-R) \cdot e^{-\frac{W_n}{L_a}} \cdot \left(1-e^{-\frac{W_d}{L_a}}\right)$$

#### $\eta_D$ loss by absorption in neutral input layer

 At short λ, η<sub>D</sub> cutoff occurs because photons are all absorbed in the neutral region at the surface. In actual Si-PD structures w<sub>n</sub> ranges from about 100 nm to 1 μm; the cutoff λ congruently ranges from about 300 nm to 400 nm.

#### $\eta_D$ loss by incomplete absorption in the depletion layer

At long λ, η<sub>D</sub> cutoff occurs because the absorption falls down.
Silicon is ≈ transparent beyond 1100 nm, since photon energy < Si energy gap. In actual Si-PD structures the depth w<sub>d</sub> can range from one to various tens of μm; given the λ-dependance of L<sub>a</sub>, the cutoff λ ranges from about 900 nm to 1100 nm.

Current Si-PDs provide high efficiency ( $\eta_D > 30\%$ ) in the visible 400nm <  $\lambda$  < 800nm.

The operation range can be extended to longer  $\lambda$  with PDs in other semiconductors: up to 1500nm with Germanium devices and up to 2000nm with InGaAs devices

# **Dark Current and Noise**

- Even without light falling on it, a finite current I<sub>B</sub> flows in a reverse-biased p-n junction. It is called **Dark Current** in PDs and reverse current in ordinary circuit component diodes.
- $I_B$  is due to spontaneous generation of free carriers by thermal effects.
- Just like in Phototubes, the shot noise of  $I_B$  is the photodiode internal noise, with effective power density (unilateral)

$$\sqrt{S_B} = \sqrt{2qI_B}$$

- The internal noise of PD devices with microelectronic-size (sensitive area <1mm<sup>2</sup>) is much lower than the input noise of even the best high-impedance preamplifiers. In the applications of microelectronic PDs the circuit noise is dominant, just like for vacuum phototubes.
- However, semiconductor PDs have dark current density j<sub>B</sub> much higher than vacuum phototubes; this fact significantly limits the active area size of semiconductor detectors that can be employed for very low-noise operation.

# Dark Current of Si-PD

In Silicon device physics and technology it is ascertained that in reverse-biased junctions with moderate electric field intensity:

- a) the dark current is mainly due to thermal generation of carriers in the depletion layer. Contribution by diffusion of minority carriers from neighbouring neutral regions are much lower and negligible in comparison.
- b) The thermal generation rate in the depletion has volume density  $n_G$  given by

$$n_G = \frac{n_i}{2\tau}$$

 $n_i = \text{intrinsic carrier density}; n_i = 1,45 \ge 10^{10} \text{ cm}^{-3}$  @ Room Temperature

 $\tau$  = minority carrier lifetime, strongly dependent on the device technology i.e on the starting material and on the fabrication process. Typical values:

- $\tau \approx \mu s$  ordinary Si technology for integrated circuits
- $\tau \approx ms$  ordinary Si technology for detector devices
- $\tau \approx 1 \div 10s$  best available Si technology for detector devices

# Dark Current and active area of Si-PD

A Si-PD with circular active area of diameter *D* (area  $A = \pi D^2/4$ ) and depletion layer thickness  $w_d$  has dark generation rate  $n_B = n_G A w$ . For setting a limit  $n_B < n_{Bmax}$  the diameter *D* must be limited

$$A < A_{max} = \frac{n_{B\max}}{n_G w_d} = \frac{2\tau n_{B\max}}{n_i w_d} \qquad D \le D_{max} = \sqrt{\frac{8\tau n_{B\max}}{\pi n_i w_d}}$$

**Example**: Si-PD with  $w_d = 10\mu$  in good Si detector technology ( $\tau \approx 10$ ms), intended to have the widest possible area with noise lower than a preamplifier with  $\sqrt{S_i} = \approx 0.01 pA / \sqrt{Hz}$ . For keeping the shot noise so low, the generation rate must be limited to  $n_{Bmax} < 10^9 s^{-1}$  which implies

$$D < D_{\text{max}}$$
=1,3cm

As we will see, the area limitation is more severe for avalanche photodiodes (APD). The APD internal gain makes negligible the role of circuit noise, hence it is the APD detector noise that limits the sensitivity and it is worth to reduce it more drastically.

**Example**: Si-APD with  $w = 10 \mu m$ , fabricated in very good Si detector technology (say  $\tau \approx 1s$ ) intended to have low dark rate, comparable to that of a good vacuum tube photocathode, say  $n_{Bmax} < 10^3 s^{-1}$  like a S20 photocathode with diameter 3cm. The limit is

$$D < D_{\max} = 130um$$

# Current signal in PDs and dynamic response

# **Carrier motion and detector current**

- Carriers drifting in depleted regions induce current at PD terminals, whereas carriers diffusing in neutral regions do NOT
- The Shockley-Ramo (S-R) theorem is still valid in presence of space charge
- Knowing the actual velocity  $v_c$  of a drifting carrier, the current induced at the PD terminals can be computed by the S-R theorem
- The motion of carriers in a semiconductor with electric field *E<sub>d</sub>* is different from that in vacuum with equal *E<sub>d</sub>* : carriers suffer scattering on the lattice and dissipate in the collisions most of the energy received from the field. No more the acceleration, but the drift velocity *v<sub>c</sub>* is a function of the field *E<sub>d</sub>*.
- In Silicon (and other materials) the motion of electrons is different from holes:
  - at **low field**  $E_d < 2 kV/cm = 0,2 V/\mu m$  the regime is **Ohmic**:  $v_c = \mu_c E_d$ (electron mobility  $\mu_n \approx 1500 \ cm^2 V^1 s^{-1}$ ; holes  $\mu_p \approx 450 \ cm^2 V^1 s^{-1}$ )
  - as  $E_d$  increases above 2kV/cm the velocity rises progressively slower
  - at  $E_{ds} \approx 20 kV/cm = 2V/\mu m$  the velocity saturates at the scattering-limited values

for electrons 
$$v_{ns} \approx 10^7 \ cm/s$$
 for holes  $v_{ps} \approx 8 \cdot 10^6 \ cm/s$ 

which are almost equal to the thermal scattering velocity  $v_{th} \approx 10^7$  cm/s

### **Carrier motion in PD**

![](_page_18_Figure_1.jpeg)

cross-section of typical PD structure

space charge density  $\rho$  in the depleted region

electric field  $E_d$  > saturation  $E_{ds}$  over almost all  $w_d$ 

Electron drift velocity  $v_n \approx v_{ns}$  over almost all  $w_d$ 

Hole drift velocity  $v_p \approx v_{ps}$  over almost all  $w_d$ 

Reference Field  $E_v$  for S-R theorem

$$E_{v} = \frac{1}{w_{d}}$$

# Single carrier motion and current

![](_page_19_Figure_1.jpeg)

# Single carrier motion and current

- The duration of a single-carrier pulse is given by the **transit time**  $T_t$  of the carrier in the depleted region. At saturated velocity it is quite short: in Silicon the carrier travel takes  $\approx 10 \text{ps/}\mu\text{m}$ , that is, with  $w_d = 1 \div 100 \mu\text{m}$  it is  $T_t = 10 \text{ps} \div 1 \text{ns}$ .
- The single-carrier pulse duration thus depends on the position of carrier generation. Rigorously, the waveform of the current due to a fast multi-photon pulse is not the convolution of the optical pulse with a standard carrier response: it is a more complex computation that depends on the spatial distribution of absorbed photons.
- However, convolution with a suitable standard single-carrier response gives the waveform with approximation adequate for most cases, at least for times longer than the carrier transit time.
- A simplifying and conservative approximation currently employed for Silicon PDs assumes as standard the response to an electron that crosses all the depletion layer.

Finite width of response implies <u>low-pass filtering in light-to-current transduction</u>: it's a mobile-mean over time  $T_t = w_d/v_{sn}$ , with upper band-limit  $1/2T_t = v_{sn}/2w_d$ .

Note the  $w_d$  trade-off: long  $w_d$  is required for high quantum efficiency at long wavelength  $\lambda$ , short  $w_d$  for ultrafast time response.

# **Photodiode Equivalent Circuit**

![](_page_21_Figure_1.jpeg)

 $I_D = S_D \cdot P_L$  photo-controlled generator ( $S_D$  radiant sensitivity or responsivity)

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- $\succ$  C<sub>D</sub> diode capacitance (p-n junction)
- *R<sub>D</sub>* diode series resistance (of the input layer and substrate)
- ➢  $R_j$  parallel resistance of the reverse biased junction is considered → ∞

![](_page_21_Figure_6.jpeg)

the load circuit is a low-pass filter with time constant  $R_L C_L$ in the transfer from detector current  $I_D$  to output voltage  $V_O$ 

# **Photodiode Dynamic Response**

In summary, the PD dynamic response is limited:

- 1. By the light-to-current transduction, with pulse response  $h_D(t)$  of finite-width  $T_t$ , well approximated by a rectangular pulse.
- 2. By the load circuit, with  $\delta$ -response  $h_L(t)$  of finite-width  $T_L \approx R_L C_L$

The  $\delta$ -response  $h_P(t)$  in the transfer from light power to detector voltage results from the convolution of the two

 $h_P(t) = h_D(t) * h_L(t)$ 

Hence the width  $T_{P}$  is the quadratic addition of the two

$$T_P = \sqrt{T_t^2 + T_L^2} = \sqrt{T_t^2 + R_L^2 C_L^2}$$

For exploiting well the fast response  $h_D(t)$  of the PD current, the load circuit does not need to have much faster response, but just comparable or slightly better

$$T_L = R_L C_L \le T_t$$

![](_page_22_Picture_13.jpeg)

# **Photodiode Dynamic Response**

For a PD in planar Silicon with depletion layer  $w_d$  and circular area A of diameter D

$$C_D = \varepsilon_{Si} \frac{A}{w_d} \qquad \qquad T_t = \frac{w_d}{v_{sn}} \approx w_d \cdot 10 \frac{ps}{\mu m}$$

Assuming (quite optimistically) that the load capacitance be given only the junction  $C_L \approx C_D$ and applying the condition  $R_L C_L \leq T_t$  we get

$$A \leq \frac{w_d^2}{v_{sn}} \frac{1}{R_L \varepsilon_{Si}}$$
 that is  $D \leq w_d \sqrt{\frac{1}{\pi v_{sn} R_L \varepsilon_{Si}}}$ 

In wide-band operation the load resistance  $R_L$  is small, but is not much less than 100  $\Omega$ (diode resistance  $\approx$  some ten Ohm and characterisic resistance of wide-band circuits 50÷75 $\Omega$ ). For exploiting well the fast response limited by the transit time, with  $R_L = 100 \Omega$ ,  $\epsilon_{si} \approx 1,06 \text{ pf/cm}$ ,  $v_{ns} \approx 10^7 \text{ cm/s}$ , the limit to the size of sensitive area is

#### $D \le 12, 5 \cdot w_d$

In the design of detector devices, the selected depletion layer depth  $w_d$  depends on the wavelength of interest and on the photon detection efficiency sought; it actually ranges from 1µm to about 100µm.

The area of fast semiconductor photodiodes thus is small in all cases: as  $w_d$  ranges from 1µm to 50µm the limit diameter correspondingly ranges from 25µm to 1,25mm